

MAY 19 2005

Application No.: 10/692,589

Docket No.: JCLA11007

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Lu et al.

Serial No. : 10/692,589

Filed : 10/24/2003

For : Hybrid Integrated Circuit Package Substrate

)
)
)
)
)
)
)
)
)
)

Examiner : Tran, Mai Huong C.

Art Unit : 2818

Docket No. : JCLA11007

No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-0710 (Order No. JCLA11007).

It's OK to enter
Mackinac
6/17/05

AMENDMENT AFTER FINAL

MAIL STOP AF
Commissioner for Patents
P.O. Box 1450
Alexandria VA, 22313-1450

Dear Sir,

In reply to the Office Action dated February 24, 2005, Applicants respectfully submit the following Amendments and Remarks.

Available Copy